

Loctite 3609 Chipbonder Surface Mount Adhesives - EFD

Product Images



Description

The Loctite 3609 Chipbonder Surface Mount Adhesive - EFD bonds surface mounted devices to circuit boards, and boasts medium to high adhesive bonding and a lead-free composition. The 3609 Chipbonder Surface Mount Adhesive -EFD uses an EFD type syringe, and is available in 30ML units. The 3609 Chipbonder Surface Mount Adhesive is ideal for users who require good wet strength, high dot profile, and who may be working with electrical features

- Surface mount adhesive
- Lead-free
- Suitable for lead-free wave soldering
- Alcohol-and-water based flux
- Good wet strength
- High dot profile
- Chemical type: epoxy
- Uncured appearance: dark red, viscous gel
- Dispense method: syringe
- Dispense speed: above 100°C
- Composed of one element: mixing free
- Unit: 30ML